

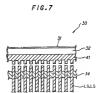


# (2) EUROPEAN PATENT APPLICATION

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- (A) Dielectric display device.
- (ii) The present invention discloses a distortion display device comprising: a pair of multivations (3.1.5.2), at least one of which in transparent, specing in a contact distance, and flexing persist to such other: a describt design sensitive of the contact distance, and flexing persist to such other: a describt design sensitive of the contact distance from a flexible of the purity of line electrodes, each electrode to purity of line electrodes, each electrode to the deposed flexing the especialises administrate of the electrodes.



#### BACKGROUND OF THE INVENTION

#### Field of the Invention

The present invention reletes to e dielectric display device, such as a liquid crystal cell and the like.

# Prior Art and Releted References

strate surfaces in a facing relation.

A delectric displey device of this kind used to date has a structure comprising; front side and back-side subdatable, et lesst one which is transparent, being disposed with a content distance spart facing parallal to each other, a dielectric display such as insulator, fermelectrics and semiconductor, being insulator, fermelectrics and semiconductor, being insulator, fermelectrics and semiconductor, being insulator of interest the part of substantials, and a perior of electrodes, at least one of which made of a plurality of line aductodes, being disposed on respective such

When a dielactric display daylor having a structure described above, is applied with selective voltagas between the electrodes facing each other on the pair of substrate surfaces, the dielectric display material inserted between the outetrates changes its state from an initial phase to enother phase. The varistion of the state causes a change of the optical characteristics of the dielectric display material such ce refrection of index, behavior of birefringence, etc. which can be used for a particular visual display means. However, there occurs stetic electricity on the substrate when, in a preparing process of a liquid cryotal cell, the substrates need be subjected to the rubbing treetment in which the surface of substrate is rubbed lightly in a direction with a cotton fabric for the purpose of aligning the molecules of liquid crystal. Meanwhile, thin film trensistors (to be abbreviated generally as TFT) and other devices having an MIM (Metal Insulator Metel) structure, have become predominantly used in recent years as e switching device for epplying selective voltages to the display electrodee of a liquid crystal cell. Such a switching device tends to have a voltage difference formed based on the static electricity above mentioned, particularly in a position where the interval of the electrodes are small. This voltage difference causes e discharge to thereby deteriorate the dielectric display material in its quality of display, shift switching characteristics, or demage the ewitching device at the worst

coming in the obligating who did in the decision. Juponese Patrick to 1, 168,278 discloses a processor for proposing a feliactic display device in which countried management of the processor of the property of the processor of being hormatically confined between glass substantes 2 and 5 opposed to such other, immaperant display electrodes (not shown) being disposed on the facing surfaces of respective substantes 2 and 3, and switching devices (not shown) made of TFB or the section of the substantial of the substantial of the electrodes. Electric lead lines 4 connected at their ends to each of the display electrodes and switching devices, action of the proteinty of the glass subsease 3 to be joined logistine or their other and by a common latest decidal section in control with a settle

nembic type liquid crystal scaled between the gless substated or all a propered in the manner descrihed above, that is, by providing e short-chuck section 5 to which of electric lead (line 4) explored together, even if static electricity is generated by the rubbing section of static electricity is generated by the rubbing section of the static electricity is generated by the rubbing section of the static electricity is generated by the rubbing section of the static electricity and the static leader static electricity and the static section of the static electricity and the static section is a static electricity and the static section is a static electricity and section is a static electricit

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scribes that, as shown in Fig. 2 to be referred to hereinafter, the periphary of the glass aubstrete 3 including the short-circuit section 5 is cut out in a direction of the thickness so as to make individual electric laad lines 4 separata before the following steps are executed. In e step, for example, at which the liquid crystal cell 1 is provided with driver integrated circuits as shown in Fig.3 to be referred to hereinefter, there is a fear that potential difference might occur due to stetic electricity caused by, for example, an operator's finger or eny conductor with which the liquid cell 1 contacts in e processing apperatus. For this reason, in order to prevent a potential difference from occurring between the eforementioned conductor and the liquid crystel cell 1, there have been several messures taken such as earthing the operator's body or the ecceratus, disposing a discharging blower or discharging bar for generating positive ions or negativa ions to eliminete the static charges appearing on the

In cutting the peripheral short-circuit section of the aforemental conventional dislection display devices, e.g., a figuid crystal cell, there is enother fear that orientation films mer electrodes in this figuid crystal cell, and delectric display material of such sea minustation, ferroelectric substance, or semiconductor had believes the electrodem right be demaped by the static electricity which is generated in cutting process by or entating diamond cutter etc.

liquid crystal cell 1, or other method.

In the liquid crystal cell 1 from which the shortcoult portion 5 has been removed, static olectric charges may be brought into the liquid crystal cell 1 when the electric lead lines 4 exposed outside mistalenty come into contact with en operator's finger or other conductors in the processing appearatus etc.

To overcome this difficulty, in a case where, as shown in Fig.3, driver integrated circuits (which will be called simply as "driver ICa") provided in the liquid crystal cell 1 (refer to Fig.2) from which the peripheral short-circuit section is removed are of the Chip-On-Film (which will be referred to es "COF") type; tape carrier packages (which will be referred to as "TCPs") 10 ere errenged on the liquid crystal cell 1 from which the short-circuit section 5 has been removed. With the provision of the TCPs 10 to each of driver ICs. (here, four driver ICs ere aquipped, for example, in view of relation between the number of pixels and the packaging density, to respective sides of the square llouki crystal call 1), the electric lead lines 4 being exnosed outside can be kept from the static electricity which could be brought from without.

Nevertheless, in a case where the Clap-Chess type arrangement in which a contening desi IC 16 and a signal side IC 16, both work as other ICs 6 for ding the laugh or speak cell, a see manded directly on the gless substrate 3. If the short-direct section 3 is not seen to the content of the c

For the liquid crystal cell 14 having a structure described immediately above, since the electric lead lines 4 still remain exposed after the scenning side IC 15 and the signal side IC 16 have been connected to be cell 14 with the short-cloud section 5 removed, it is experienced that the exposed partion might be brough this contact with conductors.

Even when a side in which neither the scanning side IC 15 not 16 side glossed, 16 side glossed, specifically the side in which the short-circuit section 5 iou due, included by an arrow 71 in Fig. 4, is made to level with the sides of the upper and lower glass substrates 2 and 3 ea shown in Fig. 5, the portion 4 of the side circle led line 4 is exposed, so that there is still e obsibility of intrusion of static charges.

Meanwhile a Japanese Patent Laying-Open Applacisin No.Nei-2-193,112 published on July 30, 1990 discloses \*e process for preparing en interconnecting substratif\*, "in which short-best sections 5 or a liquid crystel cell ere chemfened es shown in Fig.6, so the, in a case where the cell is interconnected to enother circuit substrate, the electric lead lines interconnected meet the chemfened portion in the periphery of the interconnecting substrate.

To make a liquid crystal call as shown in Fig.6, however, necessitates an extra step of chamfering the periphery of the cell by, for exemple, blowing water jet, to the liquid crystal cell from which the peripheral ehart-circuit sections 5 have been removed, resulting in high cost.

## BRIEF DESCRIPTION OF THE DRAWINGS

- Fig.1 is a perspective view showing e construction feature of e pair of substrates of aconventional dielectric display device:
- Fig.2 is a perspective view showing a state in which peripheral short-circuit action have been cut cut from the dielectric displey device in Fig.1; Fig.3 is a perspective view showing a feature in which driver ICo are provided by the COF method for the dielectric display device shown in Fig.2, from which the peripheral short-circuit sections
- have been removed; Fig.4 is a perspective view showing a feeture in which driver lOs are provided by the COG method for the dielectric display device shown in Fig.2, from which the peripheral short-drout sections have been removed;
- Fig.5 is a partially enlarged sectional view showing the portion indicated by errow in Fig.4; Fig.6 is a parapective view showing a substrate structure of another conventional dielectric display device;
  - Fig.7 is a partially enlarged plan view showing a portion of electrodes of an ective matrix the liquid crystal cell scoording to an embodiment of the present invention; Fig.8 is a plan view showing an overall configur-
- ation of the liquid crystal cell shown in Fig.7; Fig.9 is a pertially actional view of Fig.8 takan along line III-III;
- Fig. 10 is a pertially enlarged pien view showing a structure of an electrode portion before a static eresing conductor shown in Fig.3 has not yet been appearated; Pig.11 is perspective appearance view showing e
- built-in state of the liquid crystal cell shown in Fig.8; and Fig.12 is an illustration showing a method of out-
- ting peripheral short-circuit sections of the liquid crystal cell shown in Fig.8 by means of a laser

## SUMMARY OF THE INVENTION

- to the treatment of the present invention to provide a delectric display device in which, even when the adrenementioned delectric display device, such as, for example, e liquid crystal cell is brought into contact with an external conductive material, interest to the contact with an external conductive material, interest to the contact with an external conductive material, interest to the contact with an external conductive material, interest to the contact with an external conductive material, increase of the contact with an external conductive material, increase of the contact with an external conductive material, increase of the contact with an external conductive materials.
- be prevented.

  Another object of the present invention is to provide a process for preparing a dielectric display de-

vice, by which, in removing short-circuit sections of the dielectric displey device, no static charge occurs or no break of electric leed lines or no failure in connection of the lines is caused by the edges of the sides stong which the short-circuit sections have been cut out, end the short-circuit sections ere ready to be removed.

The above first object of the present invention can be achieved by providing a delective flaghty device comprising a pair of substates, at least one of which is transparent, scarling is a contest delatera, which is transparent, scarling is a contest delatera, material incarriad batheon, said pair of substates, at least one of which includes a plurality of line decrotole, each electrode being desired provided of the desired of the desired provided of the desired of th

The process for preparing a chiedric disaley device according to the present invention comprises the steps of providing a pelo of substantes, at least one of which is transparent, peoring in a constant disason, and the present control of the present disason, and the present disason, and a period of the preparing a pair of electrodes, at least one of which includes a pruntilly offine electrodes, facing the respective substantes; despoint a static energies conductor extending peripherally allong, and being specied in a constant distants on, the end of the fine electrodes, and infrasting the serves the control of the contact of clarics for the electrodes.

In eccordance with the present invention, a disclarific display marrial is invented that a space batween e pair of substrates, at least one of which is made of a transpersion substrain, and pair of sizetimes and the substrain substrain and pair of sizetimes. All instances are substrained to the substraines straines, all instances of the electrodes is provided with partially of this electrodes. A static exempts conductor in a disposed estanding peripherally along, and spaced in a constant distance from, the east of the selectrodes. With this erranguement, the east of the selectrodes. With this erranguement, the east of the resolution of the selectrodes of the selectrodes of the controlled of the selectrodes. The selectrodes of the controlled of the selectrodes of the selectrodes of the thin the device is kept free from the effect of static electricity due to the externer conductors.

In accordance with the present invention, a dielectric display material is instantial title a space between a pair of substates, at least one of which is made of a transparent substates, and spair of elsetrodes feeing such other are formed on these substates. All least one of the satisfaction is formed with a pursity of fine electrodes, which in harm are onmedial with earlier and the common with a machine tended at that erick in common with a machine medial to the common substantial and a substantial and ductor to which electrodes are commonly connected, to the common substantial and the common substantial and the limitation of state electric caused in, for example, a freetment of rubbing on orientation files. Subsequently, the light-transmissive substrates will be irreduced with a been of laser, to separate life concluded from the end of start, to separate life concluded from the end of start, to separate life the conductor files and of the confidence will not be demanged and the confluctor remains left errord be life ended of the confidence will not be from the life ended of the file ended of the file ended of the file ended on the file ended on the file ended on the file ended on the device would not be brought into a set the elsected on the ended on the ended on the file ended on the ended on th

#### DESCRIPTION OF THE PREFERRED EMBODIMENTS

Now, an embodiment of the present invention will be described hereinafler.

# 20 Embodiment:

Fig.7 is a partially enlarged plan view showing a structure of electrodes portion of en active matrix type liquid crystal os!) 30 according to an embodiment of the present invention. Fig.8 is e pien view showing en overall elemental configuration of the liquid crystal cell 30. Fig.9 is a partially sectional view of Fig.8 taken along line III-III.in the liquid crystal cell 30, there are disposed a peir of gless substrates 31 and 32, on which of their facing sides are disposed respective slectrodes. Between the class substrates 31 and 32 are injected a liquid crystal 33, which are hermeticelly scaled by an adhesive agent 34. In this figure, the surface of the upper class substrate 31 is covered in elmost entire eres with a common electrode 35. whereas the lower class substrate 32 is provided via on insulator film 36 with line electrodes for accoming LG (to be referred to as, simply, electrodes LG) and electrodes for signals LS (to be referred to as, simply, electrodes LS) making right engles with one another. In addition, a thin film trensistor (TFT) 37 and e pixel electrode 38 are arranged at each of the intersections between these electrodes LG and LS. Hera, the TFT 37 is a switching device for selectively epplying the voltage to the pixel electrode 38.

A scenning side IC 39 and a signal side IC 40 are provided in a manner of the COO method on the logises substrate 32, but whe helicitudes IQ and IS. Algarie for a scenning like generated from the scenning side IC 39 and a signal for e data like generated from the signal side IC see spoiling to expensive for the signal side IC see appoint to expensive for the signal side IC see appoint to expensive (S) of the TFT, respectively, to turn the electron 38 are and off.

On the sides of the glass substrete 32 in which self-bethe scanning side IC 39 nor the signal side IC 40 is disposed, there is formed a static erasing conductor 41 which extends peripherally along, the ends of the electrodes I.G and I.S, being spaced in e con-

The static enseing conductor 4's in formed in the same process in which the electrodes LG and LS and switching devices are formed on the glass substrate 32, by sputtaring or electron beam technique, and palterning the metal thin film constitions of, for example, Te (tentalum) using photo-tithography, in this way, the formation of the static enseing conductor 4' can be done simultaneously with the formation of the gate electrodes of TFT 37.

Thus, the static nesting conductor 41 is provided on the substates prohiberally strong the ends of the selectricides I.G and I.S with leaping a constant dissection of the selectricides I.G and I.S with leaping a constant dissection of the selectricides I.G and I.S. meaning the selectricides I.G and I.S. meaning the selectricides I.G and I.S. meaning conductor 41 even when, for instance, the liquid crystal cold So used cone is broken with one storing conductor 41 even when, for instance, the liquid crystal cold So used cone is broken with one storing the selectricides such as a condition of the selectricides of

Referring now to Figs. 10, 11 and 12, an explancion will be made on the process for presenting a likeuid crystal coll 30 hering the static erasing conductor of 4 described above. Fig. 10 are natispared faint view showing a structure of the electrode portion before the formation of the static erasing conductor 41, wherease Fig.111 is a perspective appearance view of the ligid crystal coll 30 or the triam. Fig. 12 he a view for flustwering the process of partial g a blord-fevual to the control of the collection of the collection of the beautiful control of the collection of the collection of the beautiful collection.

Referring to Fig. 10, the short-circuit section 51 to which all ends of the electrodes LG end LS, indicated by a right-sloped hatching, consisting of Ta are connected in common is formed, at the same time when the electrodes LG and LS are to be formed, on those sides of the lower glass substrate 32 in which neither the scanning side IC 39 nor the signal side IC 40 is arranged. The short-circuit section 51 is provided, as has been eteted in the description of prior art so that static charges caused by the orientation treatment and the like may not accumulate between the electrodes LG or the electrodes LS. Subsequently, the upper gleee substrate 31 is fit in and applied, as shown in Fig. 11, to assemble the liquid crystal cell 30. Here, in this case, the short-circuit section 51 is formed on the sides indicated by arrows 52 and 53, of the liquid

crystal cell 30.

On completion of the legal crystal cell 30, the short-circuit section 5 is no longer receded, so that the short-circuit section 5 is no longer receded, so that the short-circuit section 50 and 15, as shown in such and of the selections 10.0 and 15, as shown in such as the same three shorts of the short section 10.0 and 10.0 a

With regard to the kind of leser beem 55, when, for example, the electrodes (LG and LS ere of Ta, SOµm wide and 3000 Attlick, as in this embodimen, a XFE axclime laser can be used to irradiely with en aneaty density of SLIGHT or less in 15 mes to cut the electrodes LG and LS without dramaging the electrodes LG and LS without dramaging the great season of the season of the season of the lang of embod other than Ta, will be able to be out in

a similar set-up condition.

Thus, the short-circuit section 61 is cut inside the liquid crystal cell 30 by the laser beem 56, and thereby, ee shown in Fig. 7t, the static oraniag conductaria is formed outside, being spaced in e constant distance from the ends of the selectodes LG and LS, and still the upper and lower glass substrates 91 and 32 remain left outside the selectodes LG and LS.

With this structure, the electrodee LG and LS would not be touched directly from withhoutly conductors such an operator's finger and the like, so that it is possible eliminate the effect of static selectiful possible eliminate the effect of static selectiful coursed by the contact of such electric conductors. Monarower, the remaining static revenits conducted the works to electrostatically sheled the electrodes LG and LS, no that it is possible to protect these electrodes and LS, on that it is possible to protect these electrodes and the control of the co

Although the suplenation of this embodiment has been made on a transparent type liquid crystal doil, the present invantion may be also applied to a raffection type or simple matrix type liquid crystal cell. The present invention is not limited to fiquid crystal cells to the can be expliced generally to any display device was in static electricity.

As has been detailed doors, according to the present invention, even though a diselectric display device (figual orysal cell) comes into contact with en external conductor such as, for example, en operator's finger, contact portion in the processing apperatus, and the Sia ken electrodes portrol in protected by the static example, contact portrol in protected by the static existing conductor, so that it is possible to prevent the static electricity dust to contact with such conductors from penatrating into the cell from without.

According to the process for preparing a dielectric display device of the present invention, e leser beam is employed to separate from each of electrodias of the delectric display device a conductor of all of the delectric display device a conductor or short citruit section which is provided and connected in common with each of electrodes for avoiding the accumulation of those static charges between the electrodes caused during the process for prespiring the dislectric displey device, so that the upper and forer substrates of the device cannot be demanged.

With this procedure, the substitutes entirely remeils unremoved and cover the end of the extendenurillas the conventioned device in which both the upthe short-first all sections, so that conditions such as, for example, an operator's fingers and the life campaigness, to the absorbed siredly, and consequently the extension of the end of the end of the end of the process of the end of the end of the end of the process of the end of the end of the end of the other end of the e

The invention being thus described, it will be obvious that the seme mey be varied in many ways. Such variations are not to be regerded as a departure from the scope of the invention.

There are described above novel features which the skilled man will appreciate give rise to advantage. So, there are each independent aspects of the invention to be covered by the present application, irrespective of whether or not they are included within the ecope of the following claims.

Claime

A dialectric display device comprising:
 e peir of eubstratee, et least one of which

le transparent, spacing in a constant distance, and facing parallel to each other; a dielectric display material inserted be-

tween seld pair of substrates; a pair of electrodes, at least one of which includes a plurality of line electrodes, each elec-

trode being disposed facing the respective substrates; a static erasing conductor disposed extending peripherally along, end being spaced in a

constant distance from, the ends of said line electrodes.

2. A dielectric display device according to claim 1,

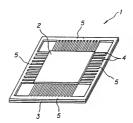
 A delectric display device eccording to claim 1, wherein said plural line electrodes facing the substrate comprise scanning side electrodes and signel side electrodes connected respectively with gete electrodes and source electrodes of TFIs disposed on the transparent substrate; said scanning side electrodes and signal eide electrodes ene respectively connected at their one ends to a driver integrated circuit for driving ocanning side electrodes and a driver integrated circuit for driving conductor is disposed along, and spaced in a constant distance from, the other ends of the scanning elde electrodes and signal side electrodes.

3. A display device comprising a pair of substrates (31, 32) which search with a reselven optimiserial, at least one of the substrates (32) carrying a parally of mutually parallel electrodes (LSLG) which estend towards an edge of the substrate, characterised by econductive element (41) which stands across, and is spaced from, the ends of each electrodes to serve as an electrostatic shallel.

 A display device eccording to claim 3, wherein said conductive element (41) is apaced from seld edge of the substrate (32).

 A method for menufecturing the displey device defined by daim 3 or claim 4, wherein the conductive element (51) is initially formed contiguous with said electrodes and subsequently electrically disconnected therefrom (41).

FIG.1



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FIG.2

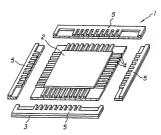


FIG.3

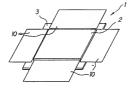
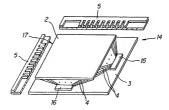


FIG.4



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FIG.5

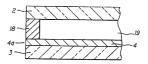
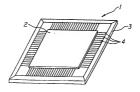
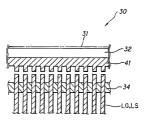
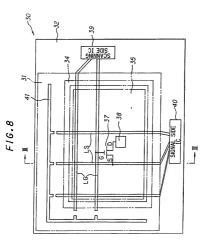


FIG.6

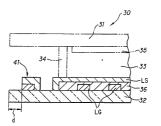


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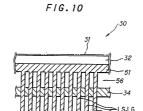




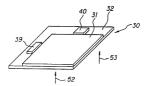
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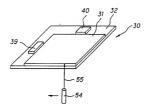
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## EUROPEAN SEARCH REPORT

Application Number

EP 92 31 1047

DOCUMENTS CONSIDERED TO BE RELEVANT				
Category	Citation of document with of relevant p	indication, where appropriate,	Reterrect to claim	CLASSIFICATION OF THE APPLICATION (Int. CLS.)
X	PATENT ABSTRACTS 0		1,3,4	G02F1/136
Y	* abstract *		2	
C	PATENT ABSTRACTS 00 vol. 14, mo. 529 (1 & JP-A-22 21 927 ( 1990 * abstract *	F JAPAN P-1133)20 November 1990 TOSHIBA ) 4 September	1,3,4	
1	PATENT ABSTRACTS OF JAPAN vol. 14, no. 148 (P-1024)20 March 1990 & JP-A-20 08 817 (MATSUSHITA ) 12 January 1990 * abstract *		2	
				TECHNICAL FIELDS SEARCHED (Int. Q.5)
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	The present search report has	been drawn up for all chains	1	
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